

# 1-MHz, 45-µA CMOS RAIL-TO-RAIL OPERATIONAL AMPLIFIER

Check for Samples: OPA2348-HiRel

### **FEATURES**

- 0°C to 70°C Known Good Die
- · Separated (Sawn) Die Mounted on Wafer Tape
- Controlled Baseline
- Low Quiescent Current (I<sub>O</sub>): 45 μA (Typ)
- Low Cost
- Rail-to-Rail Input and Output
- Single Supply: 2.1 V to 5.5 V
- Input Bias Current: 0.5 pA (Typ)
- High Speed:Power With Bandwidth: 1 MHz

### **APPLICATIONS**

- Portable Equipment
- Battery-Powered Equipment
- Smoke Alarms
- CO Detectors
- Medical Instrumentation

## **DESCRIPTION**

The OPA2348 is a single-supply low-power CMOS operational amplifier. Featuring an extended bandwidth of 1 MHz and a supply current of 45  $\mu$ A, the OPA2348 is useful for low-power applications on single supplies of 2.1 V to 5.5 V.

Low supply current of 45  $\mu$ A and an input bias current of 0.5 pA make the OPA2348 an optimal candidate for low-power high-impedance applications such as smoke detectors and other sensors.

## ORDERING INFORMATION(1)

T <sub>A</sub>	PACKAGE <sup>(2)</sup>	ORDERABLE PART NUMBER	TOP-SIDE MARKING	
0°C to 70°C	KGD	OPA2348CKGD4	NA	

<sup>(1)</sup> For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.



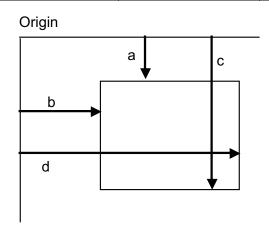
Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

<sup>(2)</sup> Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.



# **BARE DIE INFORMATION**

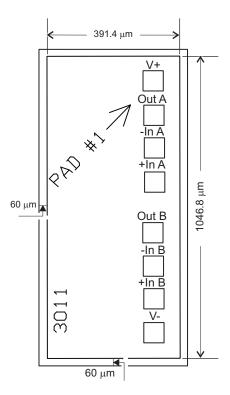
DIE THICKNESS	BACKSIDE FINISH	BACKSIDE POTENTIAL	BOND PAD METALLIZATION COMPOSITION		
10 mils.	Silicon with backgrind	V-	Al-Si-Cu (0.5%)		



**Table 1. BOND PAD COORDINATES** 

DESCRIPTION	PAD NUMBER	а	b	С	d
V+	1	965.6	5	1041.8	81.2
Out A	2	839.4	5	915.6	81.2
-In A	3	713.2	5	789.4	81.2
+In A	4	587	5	663.2	81.2
Out B	5	383.6	5	459.8	81.2
-In B	6	257.4	5	333.6	81.2
+In B	7	131.2	5	207.4	81.2
V-	8	5	5	81.2	81.2







SBOS482 – NOVEMBER 2009 www.ti.com



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

# **ABSOLUTE MAXIMUM RATINGS**(1)

over operating free-air temperature range (unless otherwise noted)

	peraulig in the air temperature railige (airinese eurorinese)	
$V_S$	Supply voltage, V- to V+	7.5 V
V <sub>IN</sub>	Input voltage, signal input terminals (2)	(V 0.5 V) to (V+ + 0.5 V)
I <sub>IN</sub>	Input current, signal input terminals (2)	10 mA
	Output short-circuit duration (3)	Continuous
$\theta_{JA}$	Thermal impedance, junction to free air (4)	97.1°C/W
T <sub>A</sub>	Operating free-air temperature	0°C to 70°C
T <sub>STG</sub>	Storage temperature	−0°C to 70°C
$T_{J}$	Operating virtual-junction temperature	70°C

- (1) Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) Input terminals are diode-clamped to the power-supply rails. Input signals that can swing more than 0.5 V beyond the supply rails should be current-limited to 10 mA or less.
- (3) Short-circuit to ground, one amplifier per package.
- (4) The package thermal impedance is calculated in accordance with JESD 51-5.

### RECOMMENDED OPERATING CONDITIONS

		MIN	MAX	UNIT
$V_S$	Supply voltage, V- to V+	2.1	5.5	V
$T_A$	Operating free-air temperature	0	70	°C

Submit Documentation Feedback

# **ELECTRICAL CHARACTERISTICS**

 $V_S$  = 2.5 V to 5.5 V,  $R_L$  = 100 k $\Omega$  connected to  $V_S/2$ ,  $V_{OUT}$  =  $V_S/2$  (unless otherwise noted)

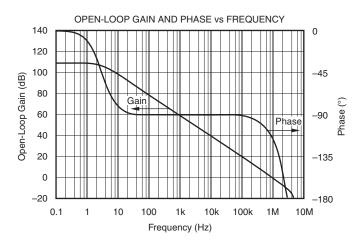
	PARAMETER	TEST CONDITIONS	T <sub>A</sub> <sup>(1)</sup>	MIN	TYP	MAX	UNIT	
V <sub>OS</sub> Input offset voltage		$V_S = 5 \text{ V}, V_{CM} = (V-) + 0.8 \text{ V}$	25°C		1	5	mV	
		VS = 0 V, VCM = (V ) 1 0.0 V	Full range			6	111.0	
ΔV <sub>OS</sub> / ΔT	Offset voltage drift over temperature	Full range 4					μV/°C	
PSRR	Offset voltage drift vs power	$V_{\rm S} = 2.5 \text{ V to } 5.5 \text{ V}, V_{\rm CM} < (\text{V+}) - 1.7 \text{ V}$	25°C		60	175	\/\/	
FORK	supply	$V_{S} = 2.5 \text{ V to 5.5 V}, V_{CM} < (V+) - 1.7 \text{ V}$	Full range			300	μV/V	
	Offset voltage channel	dc	25°C		0.2		μV/V	
	separation	f = 1 kHz	25°C		134		dB	
$V_{CM}$	Input common-mode voltage range		25°C	(V-) - 0.2		(V+) + 0.2	V	
		$(V-) - 0.2 \text{ V} < V_{CM} < (V+) - 1.7 \text{ V}$	25°C	70	82			
CMRR	Input common-mode	(V-) - 0.2 V < V <sub>CM</sub> < (V+) - 1.7 V	Full range	66			dB	
CIVILLY	rejection ratio	$V_S = 5.5 \text{ V}, (V-) - 0.2 \text{ V} < V_{CM} < (V+) + 0.2 \text{ V}$	25°C	60	71		dB	
		$V_S = 5.5 \text{ V}, (V-) < V_{CM} < (V+)$	Full range	56				
I <sub>B</sub>	Input bias current		25°C		±0.5	±10	pΑ	
Ios	Input offset current		25°C		±0.5	±10	pA	
7	land the same days as	Differential	0500		10 <sup>13</sup>   3		Ω  pF	
Z <sub>l</sub>	Input impedance	Common-mode	25°C		10 <sup>13</sup>   3			
	Input voltage noise	V <sub>CM</sub> < (V+) - 1.7 V, f = 0.1 Hz to 10 Hz	25°C		10		$\mu V_{PP}$	
V <sub>n</sub>	Input voltage noise density	V <sub>CM</sub> < (V+) - 1.7 V, f = 1 kHz	25°C		35		nV/√ <del>Hz</del>	
I <sub>n</sub>	Input current noise density	V <sub>CM</sub> < (V+) - 1.7 V, f = 1 kHz	25°C		4		fA/√Hz	
		V 5 V D 400 kO 0.025 V . V . 4.075 V	25°C	94	108		dB	
٨	Open leep voltage gain	$V_S = 5 \text{ V}, R_L = 100 \text{ k}\Omega, 0.025 \text{ V} < V_O < 4.975 \text{ V}$	Full range	90				
A <sub>OL</sub>	Open-loop voltage gain	$V_S = 5V, R_1 = 5 k\Omega, 0.125 V < V_O < 4.875 V$	25°C	90	98			
		V <sub>S</sub> = 5V, N <sub>L</sub> = 5 KΩ, 0.125 V < V <sub>0</sub> < 4.075 V	Full range	88				
		age output swing from			18	25		
	Voltage output swing from					25	mV	
	rail				100	125	111 V	
		NE = 3 K2, A <sub>OL</sub> > 30 db	Full range			125		
I <sub>SC</sub>	Output short-circuit current		25°C		±10		mA	
$C_{LOAD}$	Capacitive load drive	See Typical Characteristics	25°C					
GBW	Gain-bandwidth product	C <sub>L</sub> = 100 pF	25°C		1		MHz	
SR	R Slew rate $C_L = 100 \text{ pF}, G = +1$		25°C		0.5		V/µs	
t <sub>s</sub>	Settling time 0.1%	$C_L = 100 \text{ pF}, V_S = 5.5 \text{ V}, 2\text{V- step}, G = +1$	25°C		5		μs	
's	0.01%	σ[ = 100 pl , vg = 5.5 v, 2 v 3top, σ = 11	20 0		7		μο	
	Overload recovery time	$V_{IN} \times Gain > V_{S}$	25°C		1.6		μs	
THD+N	Total harmonic distortion plus noise	$C_L = 100 \text{ pF}, V_S = 5.5 \text{ V}, V_O = 3 \text{ V}_{PP}, G = +1, f = 1 \text{ kHz}$	25°C		0.0023		%	
1.	Ouiescent current	Per amplifier			45	65	μA	
I <sub>Q</sub> Quiescent current		rei ampiliei	Full range			75	μΑ	

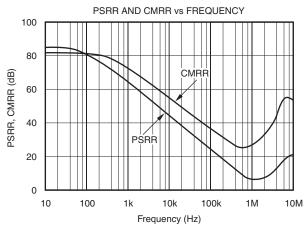
<sup>(1)</sup> Full range  $T_A = 0$ °C to 70°C

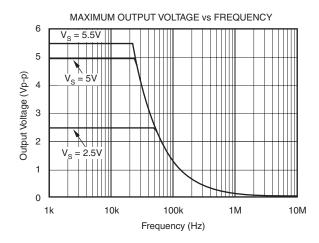


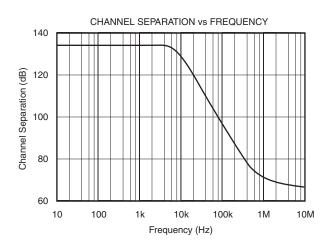
# TYPICAL CHARACTERISTICS

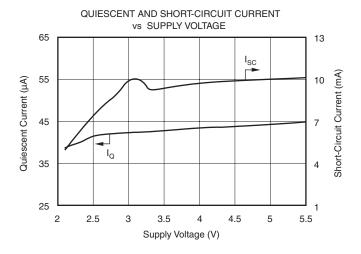
 $T_A = 25$ °C,  $R_L = 100 \text{ k}\Omega$  connected to  $V_S/2$ ,  $V_{OUT} = V_S/2$  (unless otherwise noted)

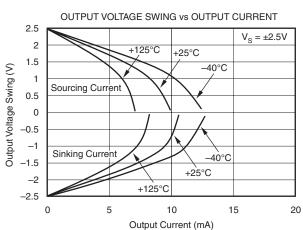










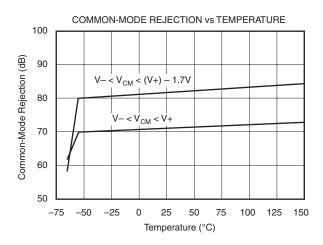


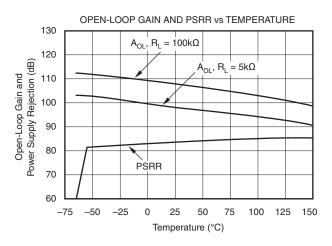


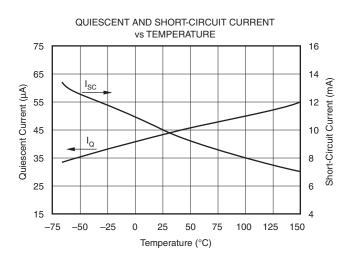
www.ti.com

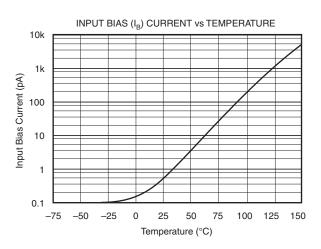
# **TYPICAL CHARACTERISTICS (continued)**

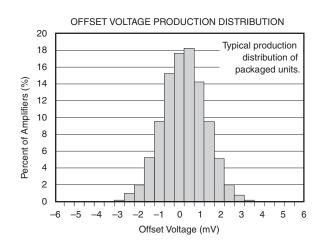
 $T_A = 25$ °C,  $R_L = 100 \text{ k}\Omega$  connected to  $V_S/2$ ,  $V_{OUT} = V_S/2$  (unless otherwise noted)

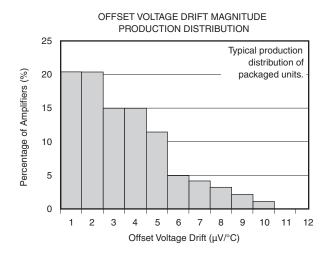








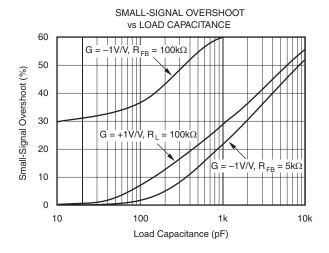


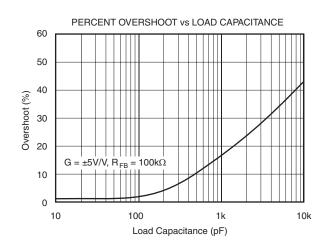


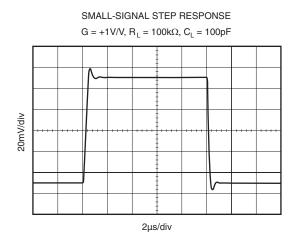
# TEXAS INSTRUMENTS

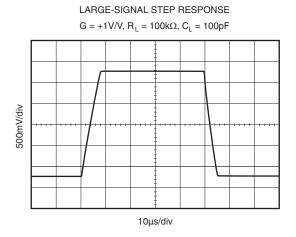
# **TYPICAL CHARACTERISTICS (continued)**

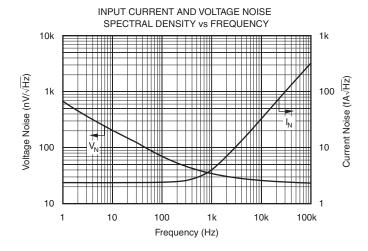
 $T_A = 25$ °C,  $R_L = 100 \text{ k}\Omega$  connected to  $V_S/2$ ,  $V_{OUT} = V_S/2$  (unless otherwise noted)

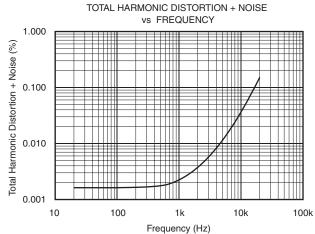












#### **APPLICATION INFORMATION**

OPA2348 op amps are unity-gain stable and suitable for a wide range of general-purpose applications.

The OPA2348 features wide bandwidth and unity-gain stability with rail-to-rail input and output for increased dynamic range. Figure 1 shows the input and output waveforms for the OPA2348 in unity-gain configuration. Operation is from a single 5-V supply with a  $100-k\Omega$  load connected to  $V_S/2$ . The input is a  $5-V_{PP}$  sinusoid. Output voltage is approximately  $4.98~V_{PP}$ .

Power-supply pins should be bypassed with 0.01-µF ceramic capacitors.

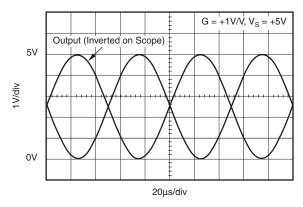


Figure 1. Rail-to-Rail Input/Output

## **Operating Voltage**

OPA2348 op amps are fully specified and tested from 2.5 V to 5.5 V. However, supply voltage may range from 2.1 V to 5.5 V. Parameters are tested over the specified supply range, a unique feature of the OPA2348. In addition, all temperature specifications apply from 0°C to 70°C. Most behavior remains virtually unchanged throughout the full operating voltage range. Parameters that vary significantly with operating voltages or temperature are shown in the *Typical Characteristics*.

### Common-Mode Voltage Range

The input common-mode voltage range of the OPA2348 extends 200 mV beyond the supply rails. This is achieved with a complementary input stage—an N-channel input differential pair in parallel with a P-channel differential pair. The N-channel pair is active for input voltages close to the positive rail, typically (V+) - 1.2 V to 300 mV above the positive supply, while the P-channel pair is on for inputs from 300 mV below the negative supply to approximately (V+) - 1.4 V. There is a small transition region, typically (V+) - 1.4 V to (V+) - 1.2 V, in which both pairs are on. This 200-mV transition region, shown in Figure 2, can vary  $\pm 300 \text{ mV}$  with process variation. Thus, the transition region (both stages on) can range from (V+) - 1.7 V to (V+) - 1.5 V on the low end, up to (V+) - 1.1 V to (V+) - 0.9 V on the high end. Within the 200-mV transition region, PSRR, CMRR, offset voltage, offset drift, and THD may be degraded compared to operation outside this region.



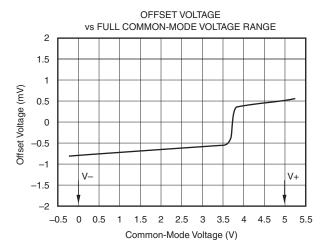


Figure 2. Behavior of Typical Transition Region at Room Temperature

## Rail-to-Rail Input

The input common-mode range extends from (V-) - 0.2 V to (V+) + 0.2 V. For normal operation, inputs should be limited to this range. The absolute maximum input voltage is 500 mV beyond the supplies. Inputs greater than the input common-mode range but less than the maximum input voltage, while not valid, do not cause any damage to the op amp. Unlike some other op amps, if input current is limited the inputs may go beyond the power supplies without phase inversion, as shown in Figure 3.

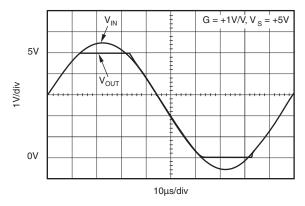


Figure 3. No Phase Inversion With Inputs Greater Than Power-Supply Voltage

Normally, input currents are 0.5 pA. However, large inputs (greater than 500 mV beyond the supply rails) can cause excessive current to flow in or out of the input pins. Therefore, as well as keeping the input voltage below the maximum rating, it is also important to limit the input current to less than 10 mA. This is easily accomplished with an input voltage resistor, as shown in Figure 4.

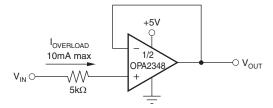


Figure 4. Input Current Protection for Voltages Exceeding the Supply Voltage

Submit Documentation Feedback

## Rail-to-Rail Output

A class AB output stage with common-source transistors is used to achieve rail-to-rail output. This output stage is capable of driving 5-k $\Omega$  loads connected to any potential between V+ and ground. For light resistive loads (>100 k $\Omega$ ), the output voltage can typically swing to within 18 mV from supply rail. With moderate resistive loads (10 k $\Omega$  to 50 k $\Omega$ ), the output voltage can typically swing to within 100 mV of the supply rails while maintaining high open-loop gain (see the typical characteristic "Output Voltage Swing vs Output Current").

## **Capacitive Load and Stability**

The OPA2348 in a unity-gain configuration can directly drive up to 250-pF pure capacitive load. Increasing the gain enhances the amplifier's ability to drive greater capacitive loads (see the typical characteristic "Small-Signal Overshoot vs Capacitive Load"). In unity-gain configurations, capacitive load drive can be improved by inserting a small (10  $\Omega$  to 20  $\Omega$ ) resistor, R<sub>S</sub>, in series with the output, as shown in Figure 5. This significantly reduces ringing while maintaining dc performance for purely capacitive loads. However, if there is a resistive load in parallel with the capacitive load, a voltage divider is created, introducing a direct current (dc) error at the output and slightly reducing the output swing. The error introduced is proportional to the ratio R<sub>S</sub>/R<sub>L</sub> and is generally negligible.

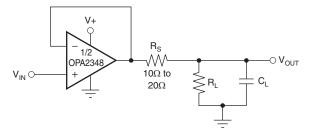


Figure 5. Series Resistor in Unity-Gain Buffer Configuration Improves Capacitive Load Drive

In unity-gain inverter configuration, phase margin can be reduced by the reaction between the capacitance at the op amp input and the gain setting resistors, thus degrading capacitive load drive. Best performance is achieved by using small-valued resistors. For example, when driving a 500-pF load, reducing the resistor values from 100 k $\Omega$  to 5 k $\Omega$  decreases overshoot from 55% to 13% (see the typical characteristic "Small-Signal Overshoot vs. Load Capacitance"). However, when large valued resistors cannot be avoided, a small (4 pF to 6 pF) capacitor,  $C_{FB}$ , can be inserted in the feedback, as shown in Figure 6. This significantly reduces overshoot by compensating the effect of capacitance,  $C_{IN}$ , which includes the amplifier's input capacitance and PC board parasitic capacitance.

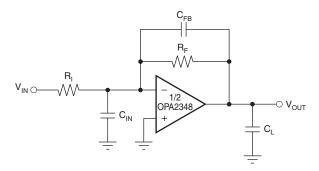


Figure 6. Improving Capacitive Load Drive

SBOS482-NOVEMBER 2009 www.ti.com



# **Driving Analog-to-Digital Converters (ADCs)**

The OPA2348 op amps are optimized for driving medium-speed sampling ADCs. The OPA2348 op amps buffer the ADC input capacitance and resulting charge injection while providing signal gain.

Figure 7 shows the OPA2348 in a basic noninverting configuration driving the ADS7822. The ADS7822 is a 12-bit, micropower sampling converter in the MSOP-8 package. When used with the low-power miniature packages of the OPA348, the combination is ideal for space-limited, low-power applications. In this configuration, an RC network at the ADC input can be used to provide for anti-aliasing filter and charge injection current.

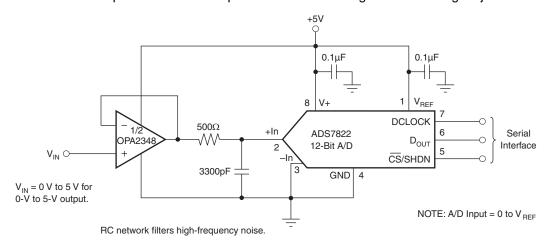
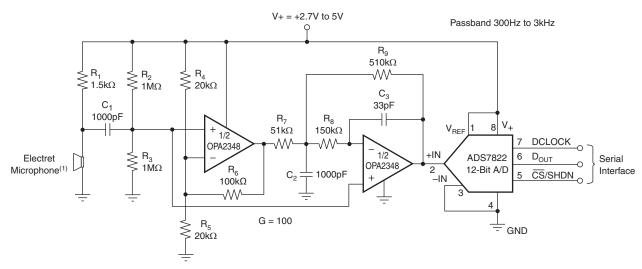


Figure 7. Noninverting Configuration Driving ADS7822

The OPA2348 can also be used in noninverting configuration driving ADS7822 in limited low-power applications. In this configuration, an RC network at the ADC input can be used to provide for antialiasing filter and charge injection current. See Figure 7 for the OPA2348 driving an ADS7822 in a speech bandpass filtered data acquisition system. This small low-cost solution provides the necessary amplification and signal conditioning to interface directly with an electret microphone. This circuit operates with V<sub>S</sub> = 2.7 V to 5 V with less than 250-µA typical quiescent current.



(1) Electret microphone powered by R<sub>1</sub>.

Figure 8. Speech Bandpass Filtered Data Acquisition System

12



## PACKAGE OPTION ADDENDUM

www.ti.com 1-Dec-2009

#### PACKAGING INFORMATION

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing		kage ty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
OPA2348CKGD4	ACTIVE	XCEPT	KGD	0	1	TBD	Call TI	Call TI

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

### **IMPORTANT NOTICE**

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

**Applications Products Amplifiers** amplifier.ti.com Audio www.ti.com/audio Data Converters Automotive www.ti.com/automotive dataconverter.ti.com DLP® Products Broadband www.dlp.com www.ti.com/broadband DSP Digital Control dsp.ti.com www.ti.com/digitalcontrol Clocks and Timers www.ti.com/clocks Medical www.ti.com/medical Military Interface www.ti.com/military interface.ti.com Optical Networking Logic logic.ti.com www.ti.com/opticalnetwork Power Mgmt power.ti.com Security www.ti.com/security Telephony Microcontrollers microcontroller.ti.com www.ti.com/telephony Video & Imaging www.ti-rfid.com www.ti.com/video RF/IF and ZigBee® Solutions www.ti.com/lprf Wireless www.ti.com/wireless

> Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2009, Texas Instruments Incorporated